

Workshop on how to write papers for IEEE Transactions on Dielectrics and Electrical Insulation (TDEI)

Venue: Universiti Teknologi Malaysia (KL Campus)*

Date: 31st March 2016, 9:00am to 5:00pm

Lead Facilitator:

Dr. Hazlee Azil Ilias (University of Malaya)

* Detailed venue will be announced soon



Registration

Name : _____
 Institution/ Company : _____
 Student : Yes/No, If Yes Matric Number: _____
 Email : _____
 Phone No : _____
 Mode of Payment : Bank Transfer/ Cheque
 DEIS Member: : Yes/No, if Yes Member ID: _____
 Signature: _____

Registration and payment must be made before **21st MARCH 2016**, space are limited. Please email the registration form and proof of payment to norasiah@utm.my

Workshop Objectives

- ✓ To understand the requirements and scope of IEEE TDEI
- ✓ To learn the skills of writing winning IEEE TDEI papers
- ✓ To encourage authors to start writing papers for IEEE TDEI

Fees

Categories	Non-DEIS Member	DEIS Member
Student	RM 250	RM 200
Regular	RM 350	RM 300

All payment must be made to IEEE DEIS Malaysian Chapter, account detailed as below:

Bank Name : CIMB Berhad
Account Name: Institut Jurutera Elektrik Dan Elektronik (USA) Cawangan Malaysia
Account No. : 8602306273

Organized By:

IEEE DEIS MALAYSIA CHAPTER

Institute of High Voltage & High Current (IVAT), Universiti Teknologi Malaysia
 University of Malaya High Voltage Research Group

